PIU

Research and Development

No. 3270

25/10/2013

**Tender@JUP<**[**tender@piu.rs**](mailto:tender@piu.rs)**>**

**Question 18:**

As for the Technical Proposal within the Documentation that should be prepared as a part of the Bid, pp. 24/116, the **Form 4.4.2** and the **Form 4.4.1.** areset forth, but we cannot find the above-mentioned forms within the issued documents, therefore, can you tell us whether those forms are omitted or is it a mistake?

Technical (administrative) bid - must not contain information about the offered price

d. Annex 2; Guarantees

* The Tender guarantee submitted pursuant to paragraph 14 in the form specified in Part I, Form 3.3
* Letter of Intent of a commercial bank for issuance of advance payment guarantee, in the percentage of the advance payment in accordance with Annex 3 to the Agreement and Sub clause 5.2 pursuant to the terms of the Agreement, Form 4.4.2
* Letter of Intent of a commercial bank for issuance of a performance bond in the percentage of the amount in accordance with the terms of the Agreement, sub-paragraph 7.1.4, Form 4.4.1

Thank you